

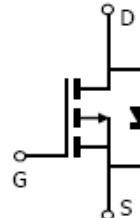
FNK P-Channel Enhancement Mode Power MOSFET

Description

The FNK55P30PD uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = -55V, I_D = -30A$
- $R_{DS(ON)} < 40m\Omega @ V_{GS} = -10V$

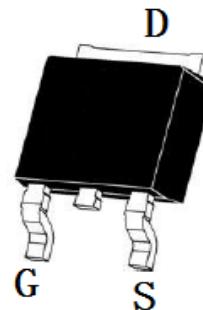


Schematic diagram

- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
FNK5530PD	FNK5530PD	TO-252	-	-	-

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-55	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	-30	A
Drain Current-Continuous($T_c=100^\circ C$)	$I_D (100^\circ C)$	-21	A
Pulsed Drain Current	I_{DM}	-120	A
Maximum Power Dissipation	P_D	65	W
Derating factor		0.43	W/ $^\circ C$
Single pulse avalanche energy ^(Note 5)	E_{AS}	87	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^\circ C$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{\theta JC}$	2.3	$^\circ C/W$
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Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

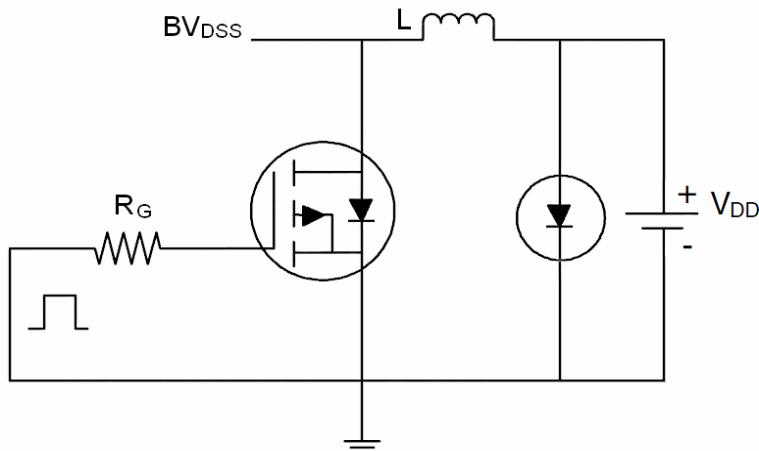
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-55	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=-55\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	±100	nA
On Characteristics ^(Note 3)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-2	-2.6	-4	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-15\text{A}$	-	31	40	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$\text{V}_{\text{DS}}=-25\text{V}, \text{I}_D=-16\text{A}$	8	-	-	S
Dynamic Characteristics ^(Note 4)						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=-15\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $\text{F}=1.0\text{MHz}$	-	5365	-	PF
Output Capacitance	C_{oss}		-	260	-	PF
Reverse Transfer Capacitance	C_{rss}		-	215	-	PF
Switching Characteristics ^(Note 4)						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=-30\text{V}, \text{I}_D=-15\text{A}$ $\text{V}_{\text{GS}}=-10\text{V}, \text{R}_{\text{GEN}}=3\Omega$	-	12	-	nS
Turn-on Rise Time	t_r		-	15	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	38	-	nS
Turn-Off Fall Time	t_f		-	15	-	nS
Total Gate Charge	Q_g	$\text{V}_{\text{DS}}=-30\text{V}, \text{I}_D=-15\text{A},$ $\text{V}_{\text{GS}}=-10\text{V}$	-	56	-	nC
Gate-Source Charge	Q_{gs}		-	11	-	nC
Gate-Drain Charge	Q_{gd}		-	24	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_S=-15\text{A}$	-	-	1.2	V
Diode Forward Current ^(Note 2)	I_S		-	-	-30	A
Reverse Recovery Time	t_{rr}	$\text{TJ} = 25^\circ\text{C}, \text{IF} = -15\text{A}$ $\text{di}/\text{dt} = 100\text{A}/\mu\text{s}$ ^(Note 3)	-	-	71	nS
Reverse Recovery Charge	Q_{rr}		-	-	170	nC

Notes:

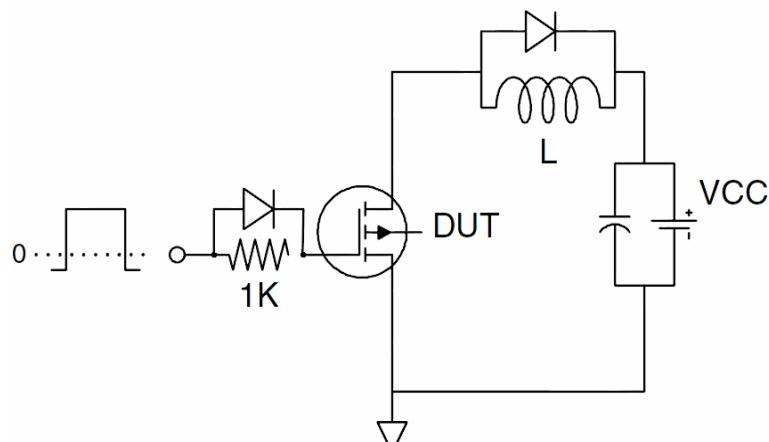
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
 2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
 4. Guaranteed by design, not subject to production
5. E_{AS} condition: $\text{Tj}=25^\circ\text{C}, \text{V}_{\text{DD}}=-25\text{V}, \text{V}_{\text{G}}=-20\text{V}, \text{L}=0.5\text{mH}, \text{R}_g=25\Omega, \text{I}_{\text{AS}}=29\text{A}$

Test Circuit

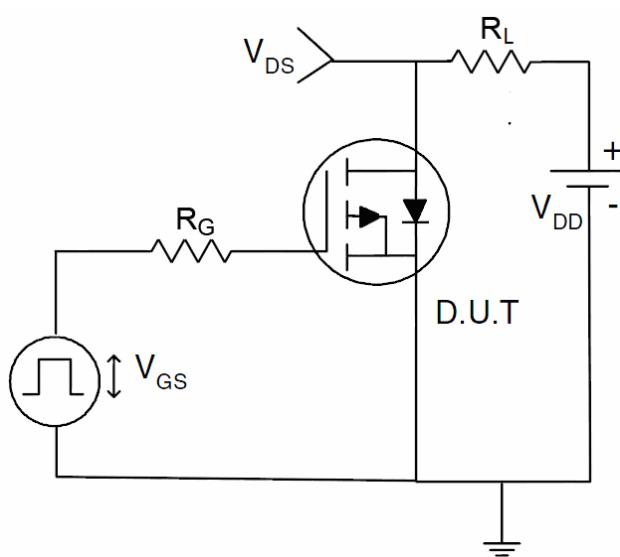
1) E_{AS} Test Circuit

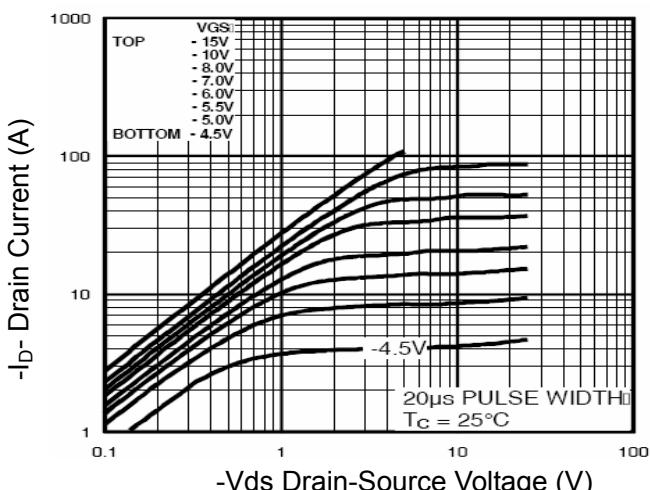
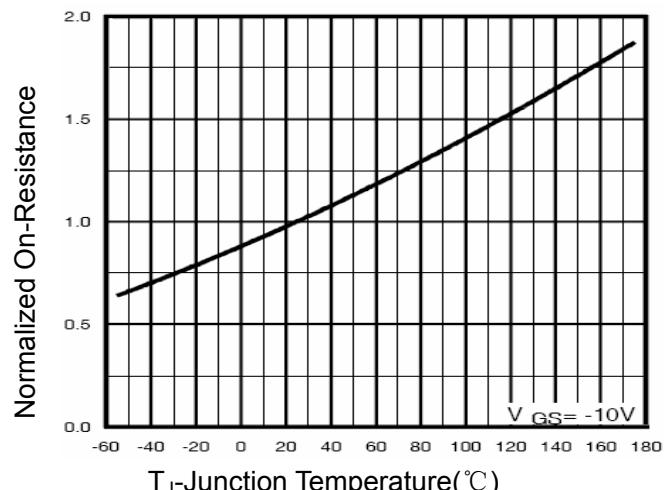
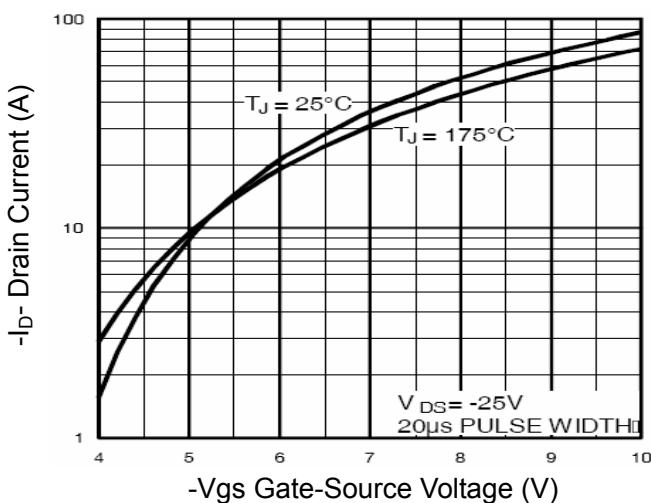
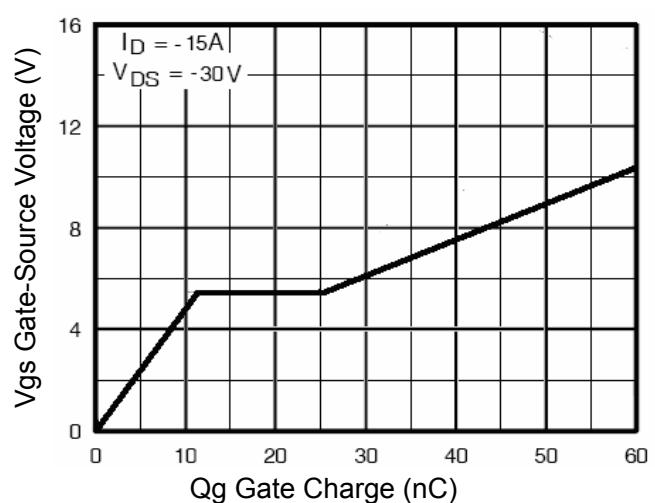
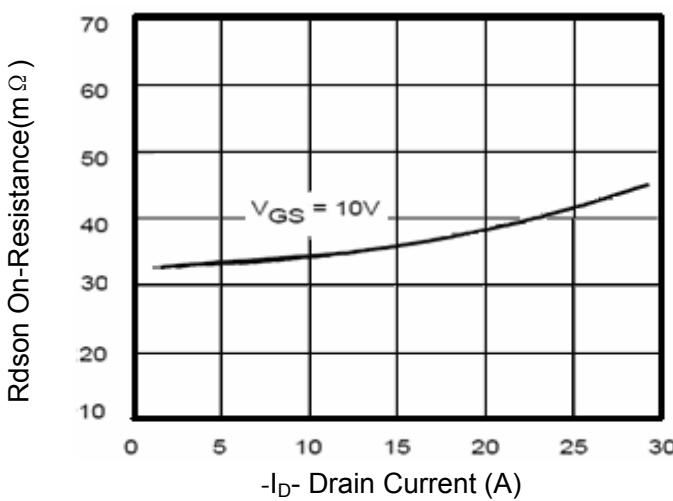
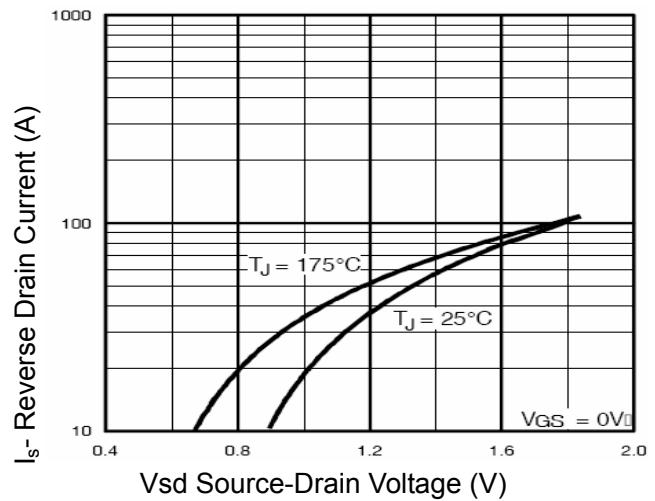


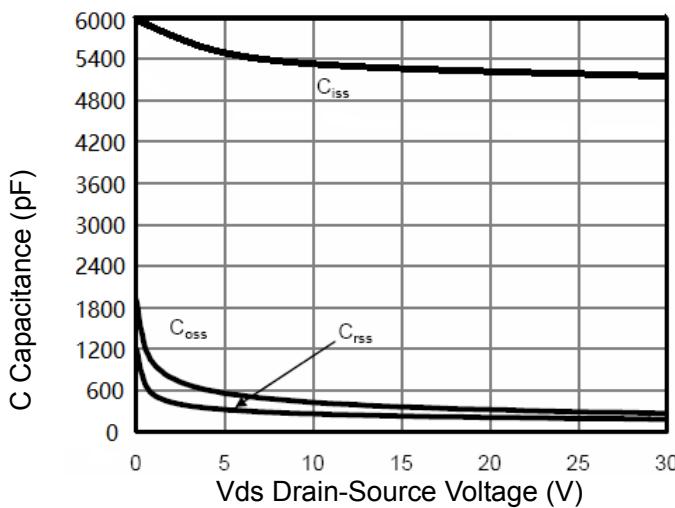
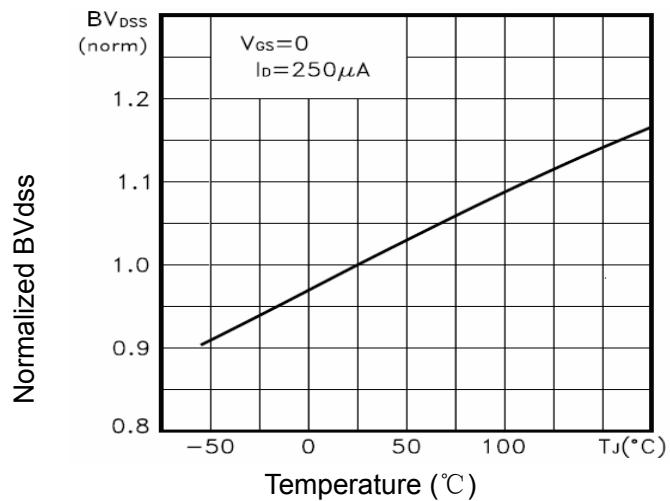
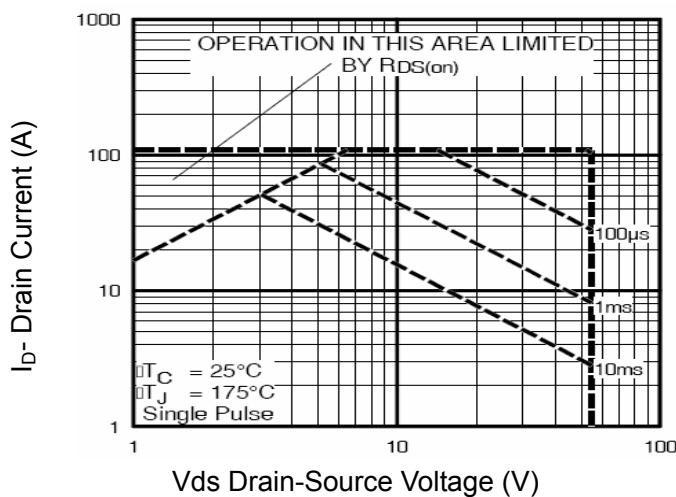
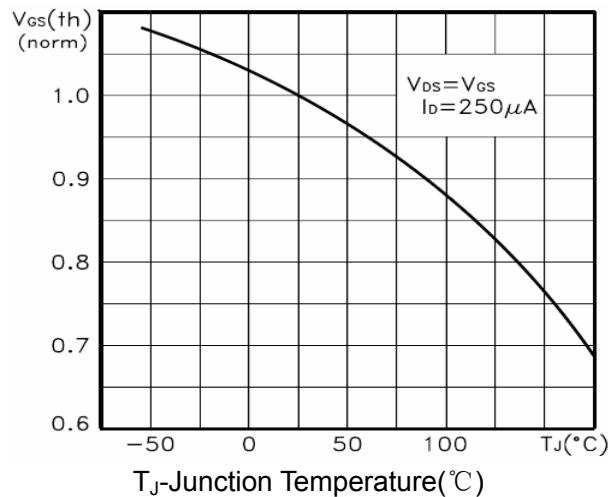
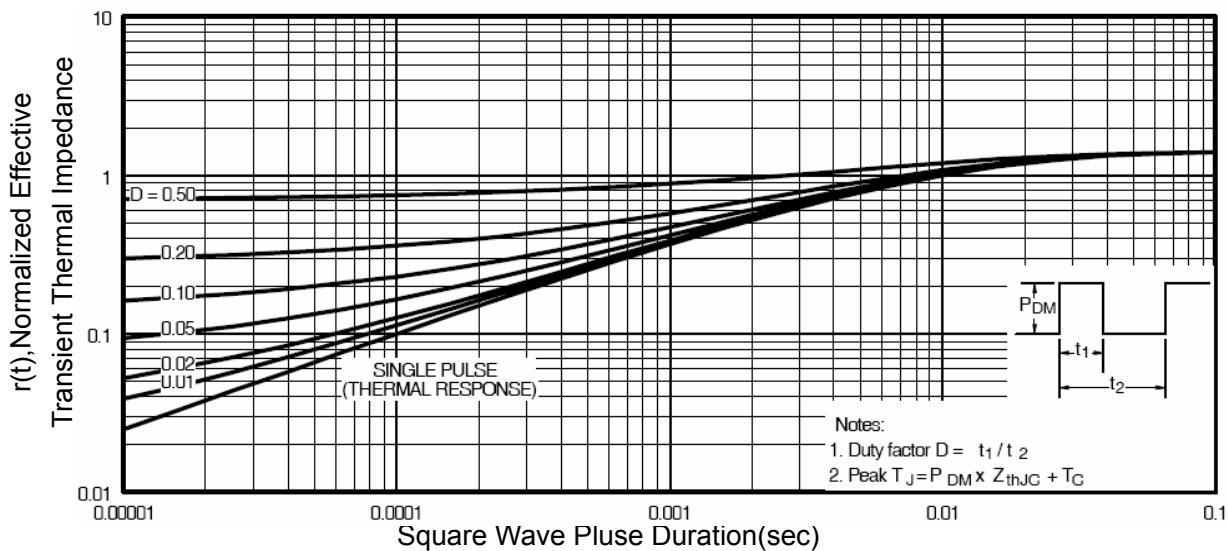
2) Gate Charge Test Circuit

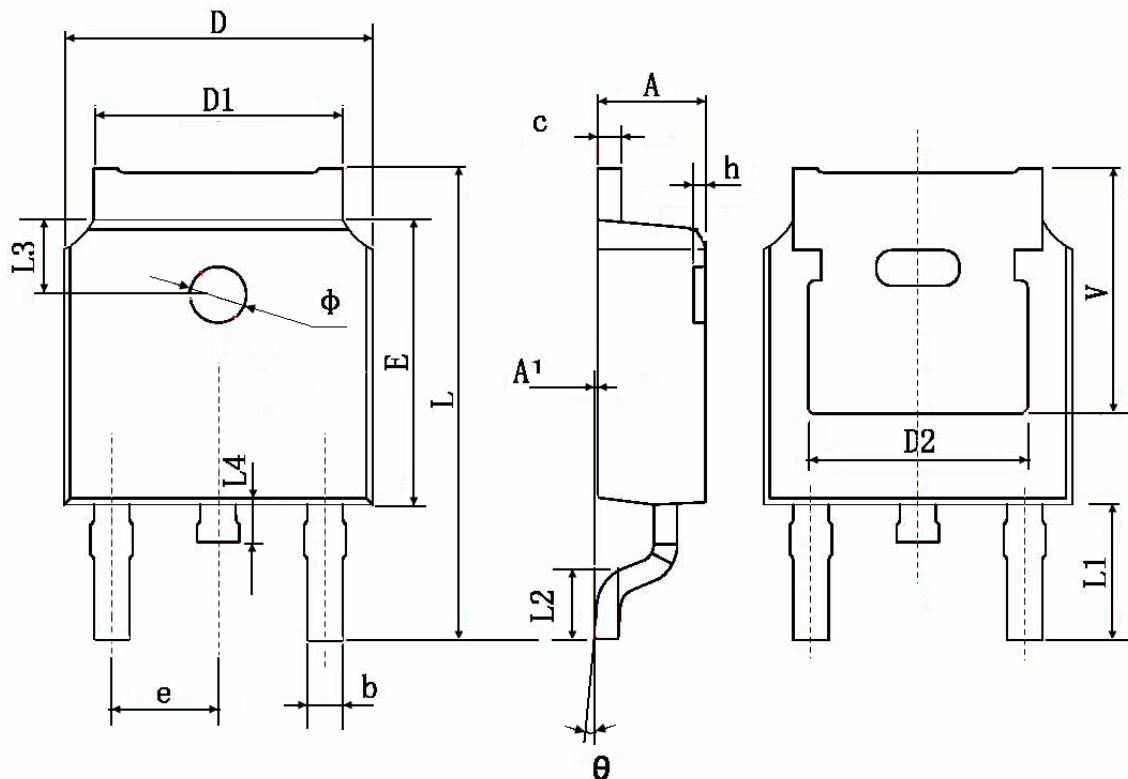


3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

Figure 1 Output Characteristics

Figure 4 Rdson-JunctionTemperature

Figure 2 Transfer Characteristics

Figure 5 Gate Charge

Figure 3 Rdson- Drain Current

Figure 6 Source- Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 9 BV_{DSS} vs Junction Temperature

Figure 8 Safe Operation Area

Figure 10 $V_{GS(th)}$ vs Junction Temperature

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252 Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A ¹	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D ¹	5.100	5.460	0.201	0.215
D ²	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L ¹	2.900 TYP.		0.114 TYP.	
L ²	1.400	1.700	0.055	0.067
L ³	1.600 TYP.		0.063 TYP.	
L ⁴	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	

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